


# Demo Board For RV1106

RV1106G AI IPC V1.3

Reference Design Main Functions Introduction	
Power	4 DCDC + 4 LDO ( or 3 DCDC + 4 LDO)
RAM	SPI FLASH
Interface	SDMMC/SDIO/MIPI CSI/LVDS_RX/VI_CIF/ VI_BT656/VI_BT1120/I2S/USB/ADC

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Project:	RV1106G AI IPC				
File:	00.Cover Page				
Date:	Friday, November 10, 2023			Rev:	V1.3
Designed by:	Linxu	Reviewed by:	Default	Sheet:	1 of 20

Catalogue	
Page	Description
Page01	00.Cover Page
Page02	01.Index and Notes
Page03	02.Revision History
Page04	03.Block Diagram
Page05	04.Power Diagram and Sequence
Page06	06.IO Power Domain Map
Page07	10.RV1106G Power/Codec/ETH/USB
Page08	11.RV1106G OSC/RTC/PMU/VCCIO
Page09	12.RV1106G ADC/FLASH/SDMMC
Page10	13.RV1106G SDIO/LCD/VICAP/MIPI
Page11	20.Power-System
Page12	45.VI-Camera Power
Page13	47.VI-Camera Master
Page14	48.VI-Camera Slave
Page15	50.VO-MCU Panel
Page16	63.WIFI-USB
Page17	68.Ethernet-FEPHY Embed
Page18	70.Audio Port
Page19	82.Micro-SD Card/IRCUT/CDS
Page20	99.Mark/Hole
Page21	

# Index and Notes

## Note

### NOTE 1:

Component parameter description

1. DNP stands for component not mounted temporarily
2. If Value or option is DNP, which means the area is reserved without being mounted

### NOTE 2:

Please use our recommended components to avoid too many changes.  
For more informations about the second source,please refer to our AVL.

## Generate Bill of Materials

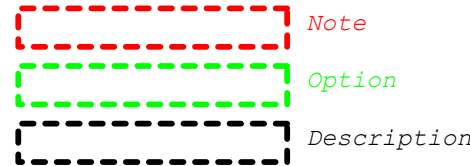
### Header:

Item\tPart\tDescription\tPCB Footprint\tReference\tQuantity\tOption


### Combined property string:

{Item}\t{Value}\t{Description}\t{PCB Footprint}\t{Reference}\t{Quantity}\t{Option}

## Graphic Description




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Project:	RV1106G AI IPC		
File:	01.Index and Notes		
Date:	Friday, November 10, 2023		Rev: V1.3
Designed by:	Linux	Reviewed by:	Default
		Sheet:	2 of 20

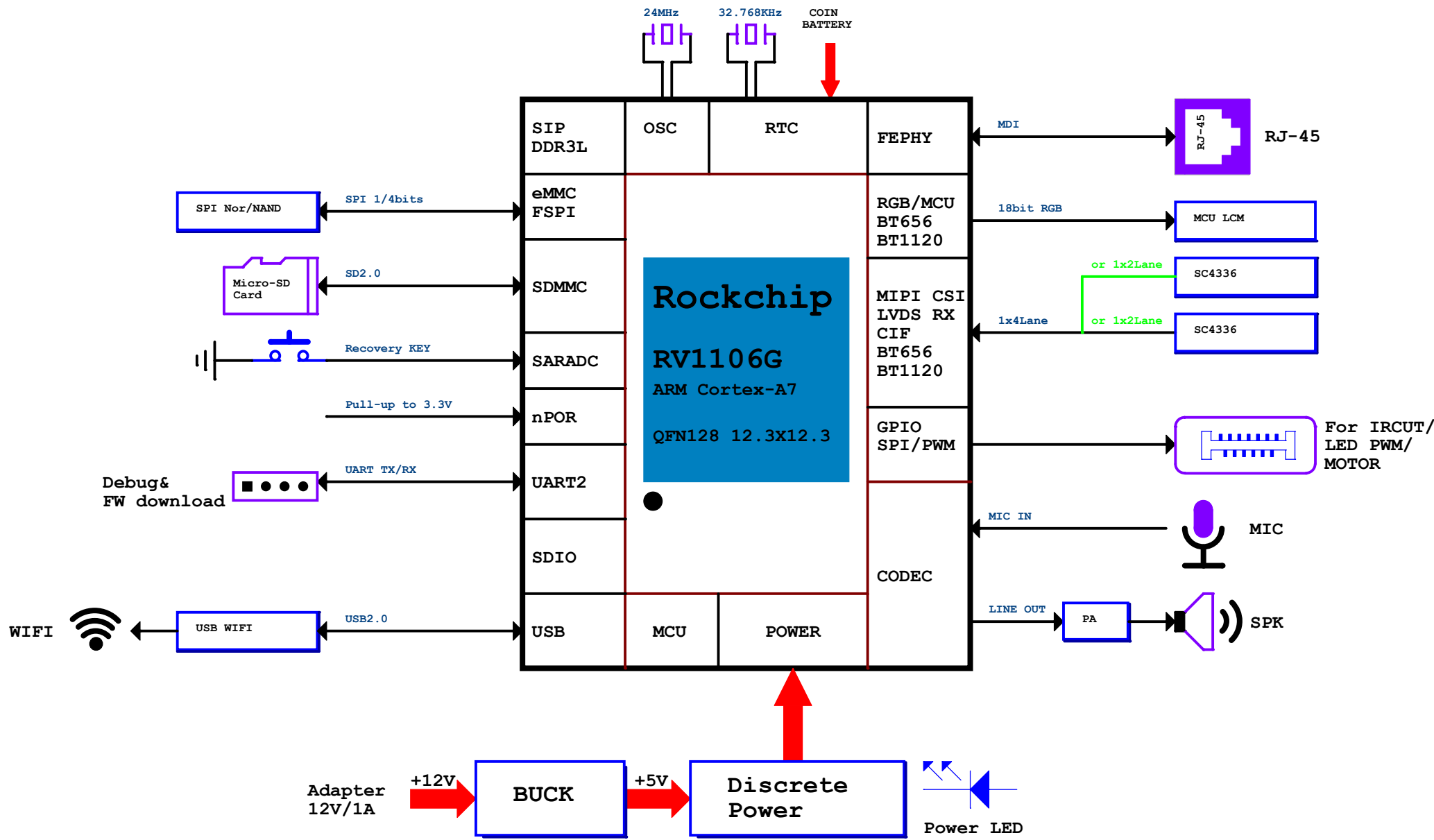
# Revision History

Version	Date	Author	Change Note	Approved
V1.0	2022.04.21	Linxu	First edition;	
V1.1	2022.05.27	Linxu	1.Update RV1106G symbol; 2.Change netname of SDMMC0 to SDMMC; 3.Change C1000 to 4.7uF. 4.Change R2005 to 47K. 5.Change DOVDD1V8 to DOVDD 1V8. 6.Add R1006 and connect R8100 to CODEC_AVSS 7.Swap R8100/R8101 and C8101/C8102.	
V1.2	2022.11.14	Linxu	1.Change R1110 to 1K and C1114 to 10nF; 2.Add R1111/R1112; 2.Add FB1001;	
V1.3	2023.11.10	Linxu	1.Add ED6000 / ED6001. 2.Add USB WIFI / Motor Drive / MCU LCM circuit. 3.Add VO / VI / Power Description. 4.Add IRCUT U9901. 5.Delete AVDD1V5 SENSOR Power circuit. 6.Delete TP1202 / TP1203. 7.Change R8204 to 4.7uF, L4700 to L0402. 8.Modify SC530AI to 2xSC4336 for dual-camera. 9.Change R1106 / R1108 to 510R.	

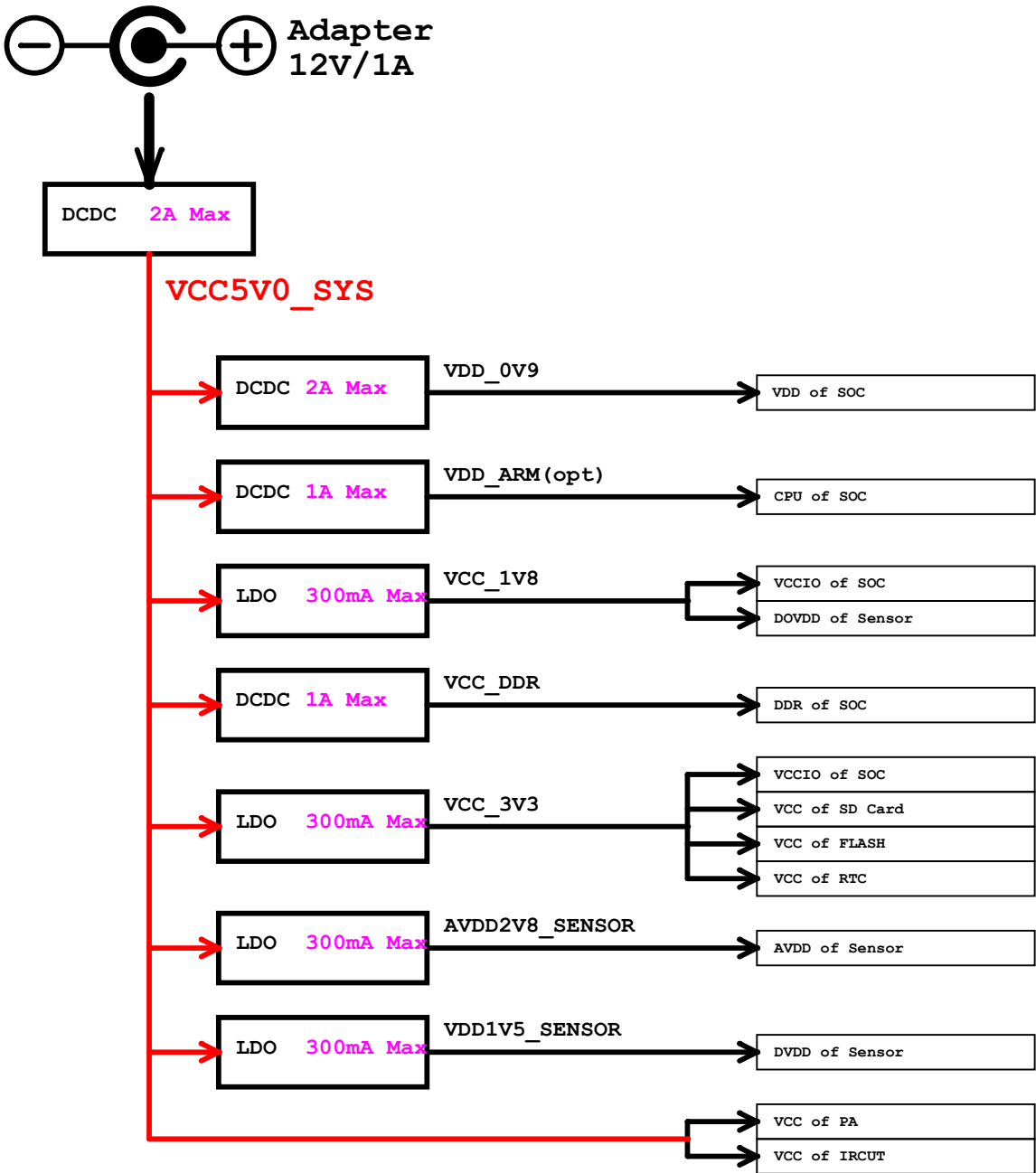
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Project:	RV1106G AI IPC				
File:	02.Revision History				
Date:	Friday, November 10, 2023			Rev:	V1.3
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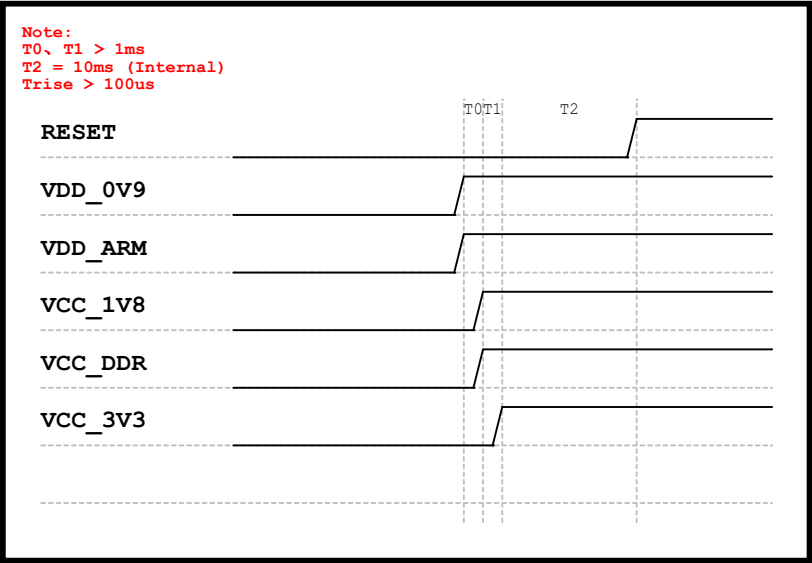
Block Diagram



Power Diagram and Sequence



Power-on Sequence				
Power Name	PMIC Channel	Time Slot	Default voltage	Peak Current
VCC5V0_SYS	DC-DC BUCK		5.0V	1.5A
VDD_0V9	DC-DC BUCK	Slot: 1	0.88V	1.6A
VDD_ARM	DC-DC BUCK	Slot: 1	0.90V	0.5A
VCC_1V8	LDO	Slot: 2	1.80V	0.1A
VCC_DDR	DC-DC BUCK	Slot: 2	1.35V	0.5A
VCC_3V3	LDO	Slot: 3	3.30V	0.2A
RESET	Finally , nPOR RESET 10ms after VCC 3V3 is ready			



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Project:	RV1106G AI IPC			
File:	04.Power Diagram and Sequence			
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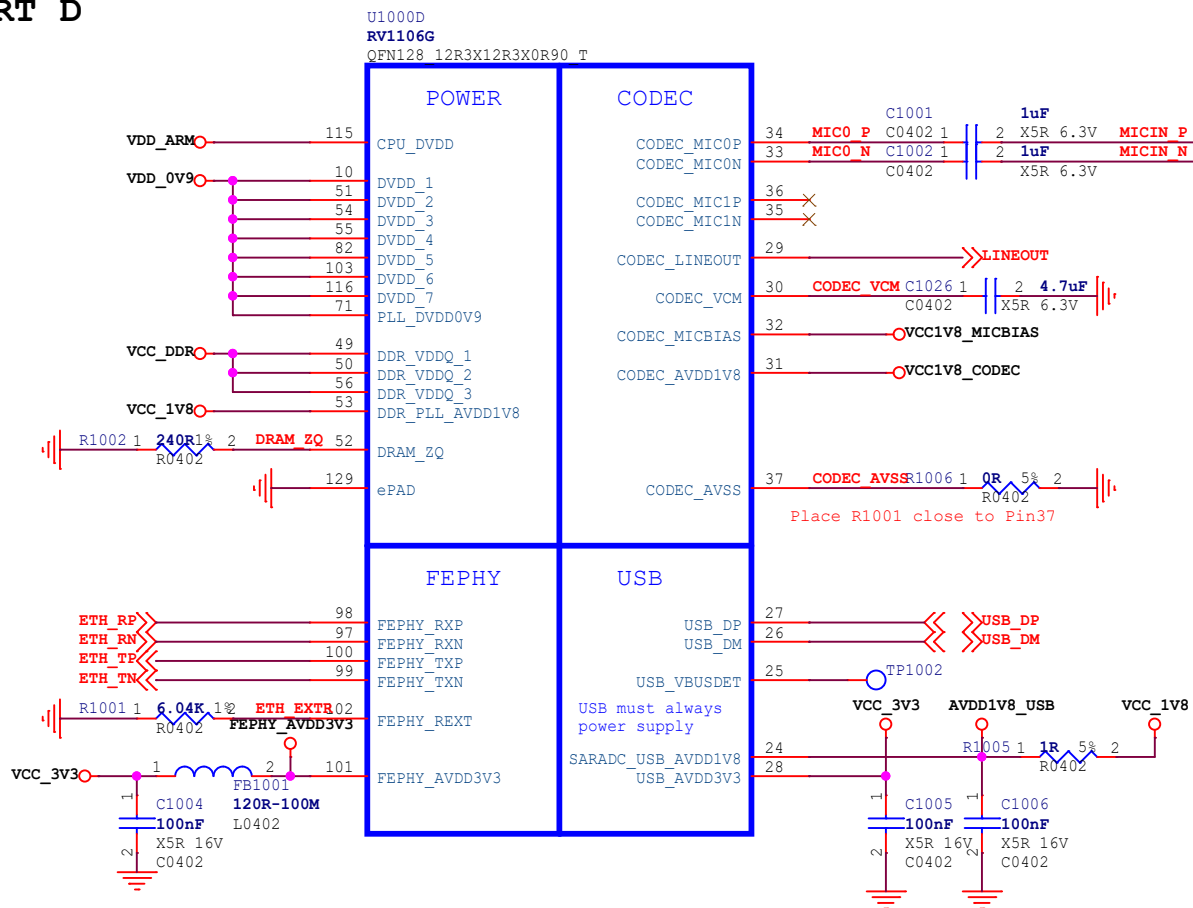
IO Power Domain Map

IO Domain	IO Group	Support of IO Voltage		Default Actual assigned IO Domain Voltage			Remark
		1.8V	3.3V	Net Name of Power Supply	Power Source	Voltage	
PMU	Group GPIO0_A		✓	VCC_3V3		3.3V	
VCCIO1	Group GPIO1_AB		✓	VCC_3V3		3.3V	
VCCIO2	Group GPIO4_C	✓		VCC_1V8		1.8V	
VCCIO3	Group GPIO4_AB	✓	✓	VCCIO_FLASH		1.8/3.3V	
VCCIO4	Group GPIO3_A	✓	✓	VCCIO_SD		1.8/3.3V	
VCCIO5	Group GPIO2_AB	✓	✓	VCC_3V3		3.3V	
VCCIO6	Group GPIO1_CD	✓	✓	VCC_3V3		3.3V	
VCCIO7	Group GPIO3_BCD	✓		VCC_1V8		1.8V	

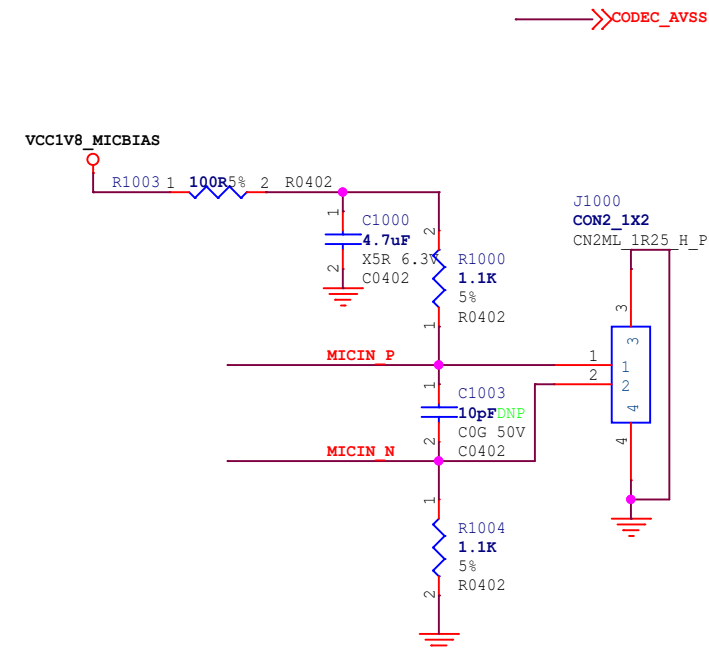
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Project:	RV1106G AI IPC					
File:	06.IO Power Domain Map					
Date:	Friday, November 10, 2023				Rev:	V1.3
Designed by:	Linux	Reviewed by:	Default	Sheet:	6 of 20	

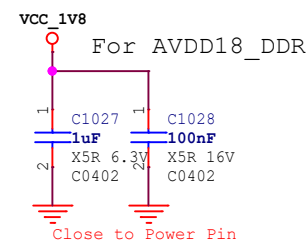
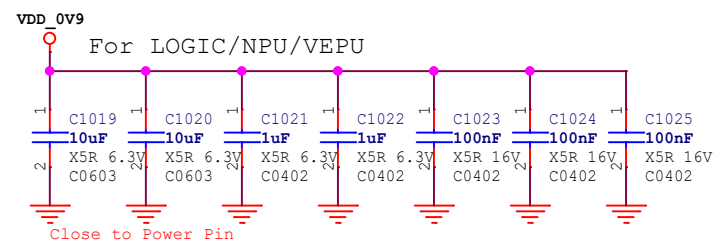
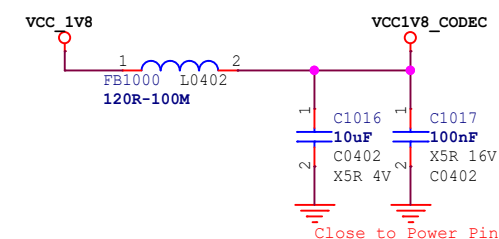
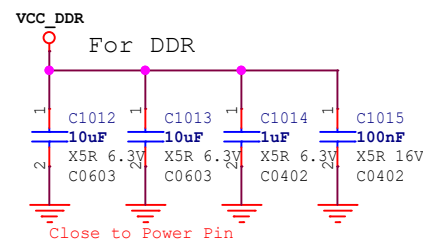
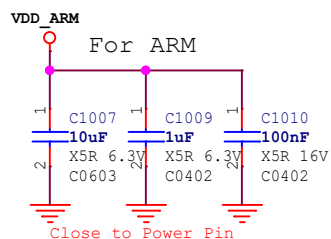
## PART D




**MIC IN**



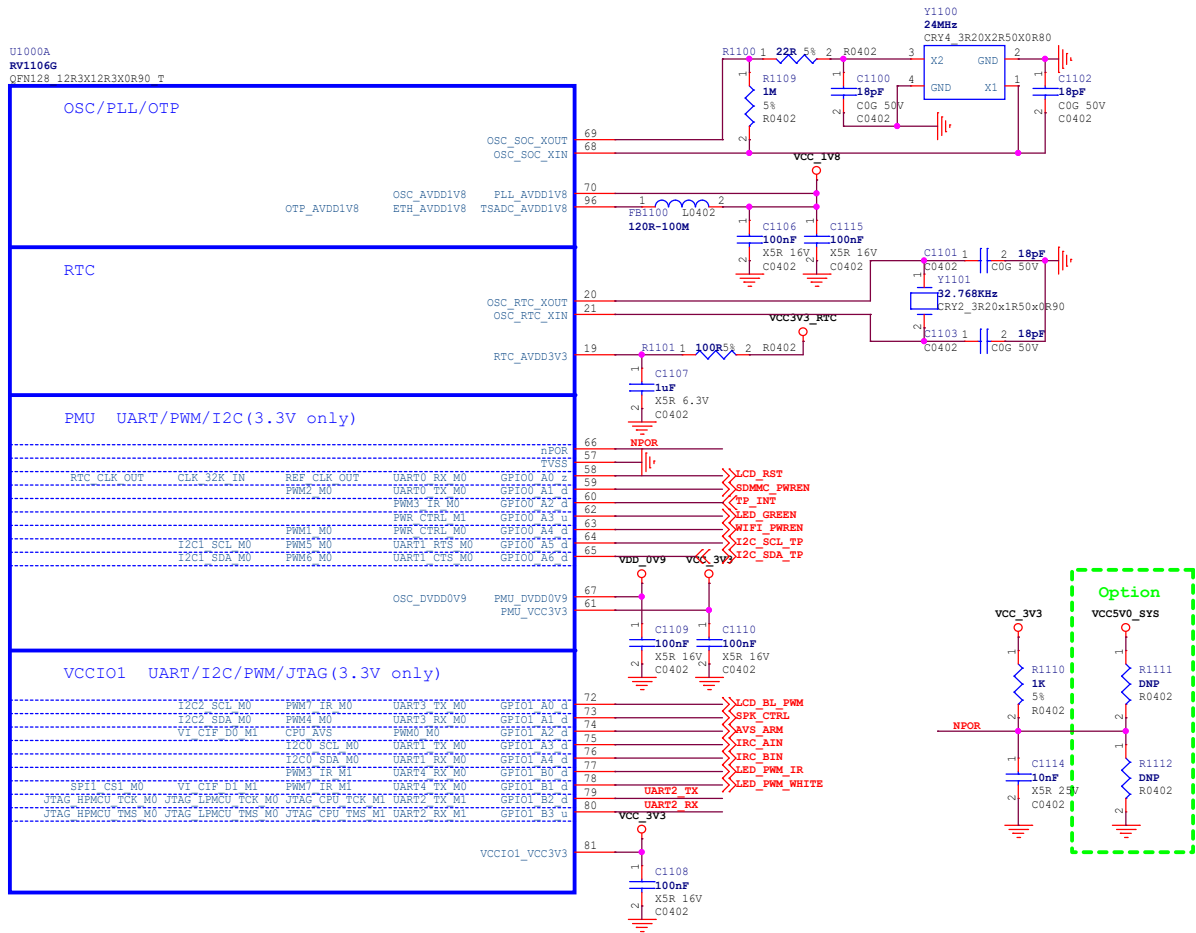
## POWER



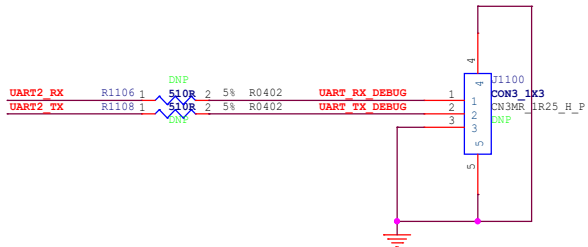
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<b>Project:</b>	<b>RV1106G AI IPC</b>
<b>File:</b>	<b>10.RV1106G Power/Codec/ETH/USB</b>
<b>Date:</b>	Friday, November 10, 2023
<b>Rev:</b>	V1.3
<b>Designed by:</b>	Linxu
<b>Reviewed by:</b>	Default
<b>Sheet:</b>	7 of 20

PART A



UART



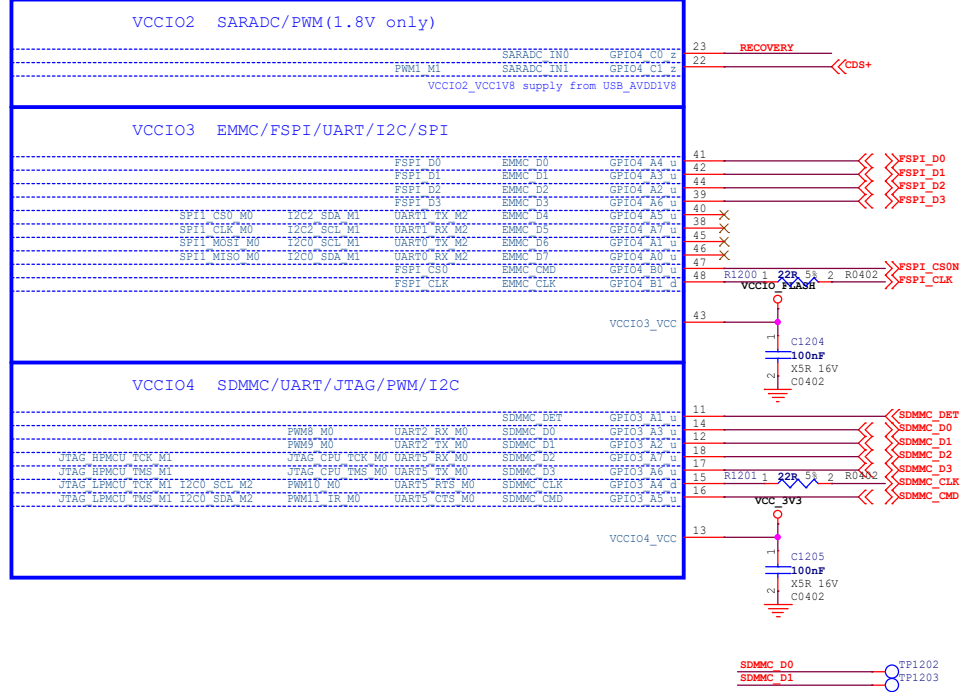
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Project:	RV1106G AI IPC		
File:	11.RV1106G OSC/RTC/PMU/VCCIO		
Date:	Friday, November 10, 2023	Rev:	V1.3
Designed by:	Linux	Reviewed by:	Default
Sheet:	8	of	20

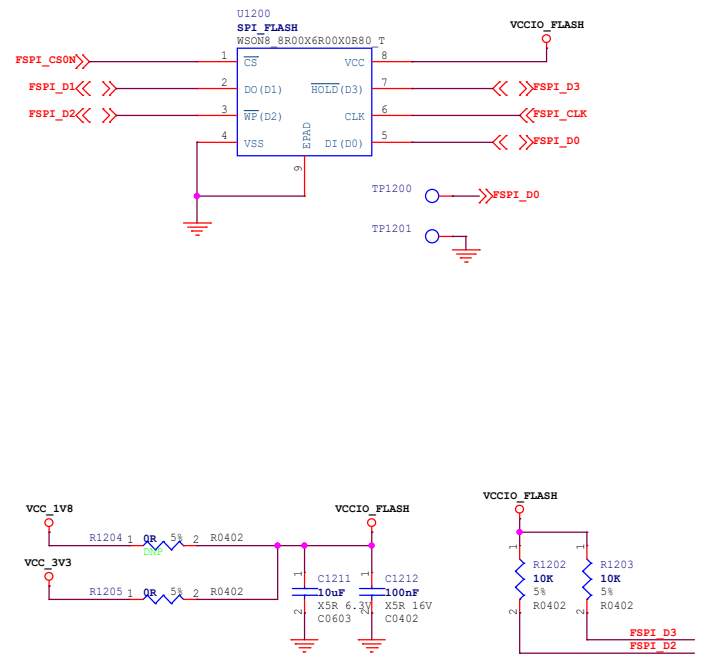


U1000B  
RV1106G  
OFN128 12R3X12R3X0R90 T



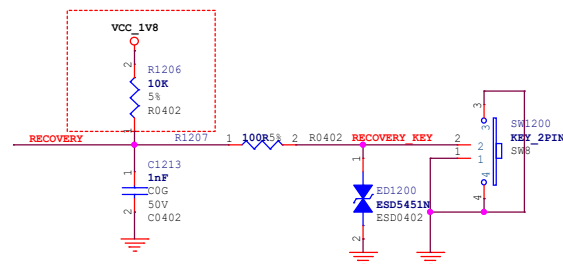
SPI Flash

NOTE:  
Refer to the latest AVL for parts selection.



RECOVERY Key

Note:  
SARADC\_IN0 must always be pulled-up.



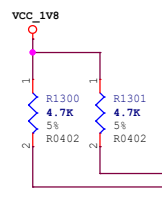
U1000C  
RV1106G  
QFN128 12R3X12R3X0R90 T



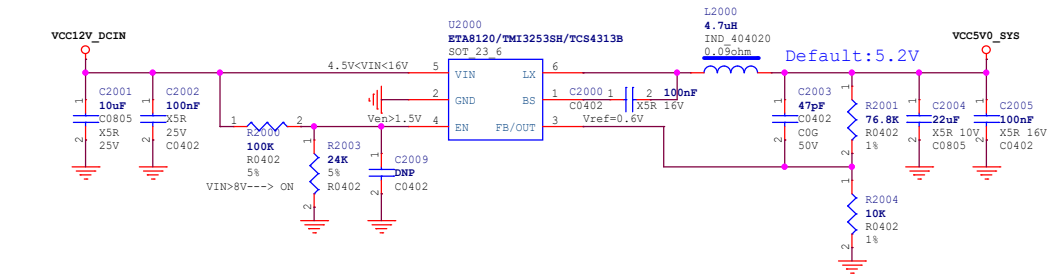
Mode	MCU	4-SPI 8bit interface II
VO_LCDC_D7	LCD_D7	SPI_CS (LCD_CS)
VO_LCDC_D6	LCD_D6	SPI_CLK (LCD_SCL)
VO_LCDC_D5	LCD_D5	SPI_MOSI (LCD_SDI/SDA)
VO_LCDC_D4	LCD_D4	SPI_MISO (LCD_SDO)
VO_LCDC_D3	LCD_D3	SPI_DCX (LCD_DCX)
VO_LCDC_D2	LCD_D2	--
VO_LCDC_D1	LCD_D1	--
VO_LCDC_D0	LCD_D0	--
VO_LCDC_DEN	LCD_RDN	--
VO_LCDC_HSYNC	LCD_WRN	--
VO_LCDC_VSYNC	LCD_CSN	--
VO_LCDC_CLK	LCD_RS	--

Mode	MIPI 1*4 lane	MIPI 2*2 lane
MIPI/LVDS_D0P	MIPI/LVDS_D0P	MIPI/LVDS0_D0P
MIPI/LVDS_D0N	MIPI/LVDS_D0N	MIPI/LVDS0_D0N
MIPI/LVDS_CLK0P	MIPI/LVDS_CLKP	MIPI/LVDS0_CLKP
MIPI/LVDS_CLK0N	MIPI/LVDS_CLKN	MIPI/LVDS0_CLKN
MIPI/LVDS_D1P	MIPI/LVDS_D1P	MIPI/LVDS0_D1P
MIPI/LVDS_D1N	MIPI/LVDS_D1N	MIPI/LVDS0_D1N
MIPI/LVDS_D2P	MIPI/LVDS_D2P	MIPI/LVDS1_D0P
MIPI/LVDS_D2N	MIPI/LVDS_D2N	MIPI/LVDS1_D0N
MIPI/LVDS_CLK1P	--	MIPI/LVDS1_CLKP
MIPI/LVDS_D3P	--	MIPI/LVDS1_D1P
MIPI/LVDS_D3N	MIPI/LVDS_D3N	MIPI/LVDS1_D1N

Support 1x4lane or 2\*2lane MIPI/LVDS input

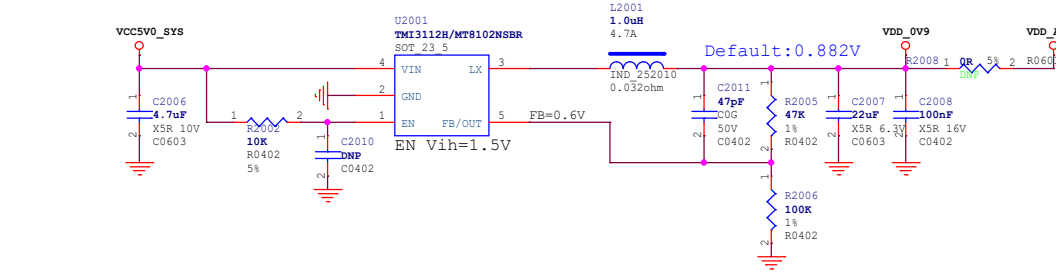


VCC5V0\_SYS

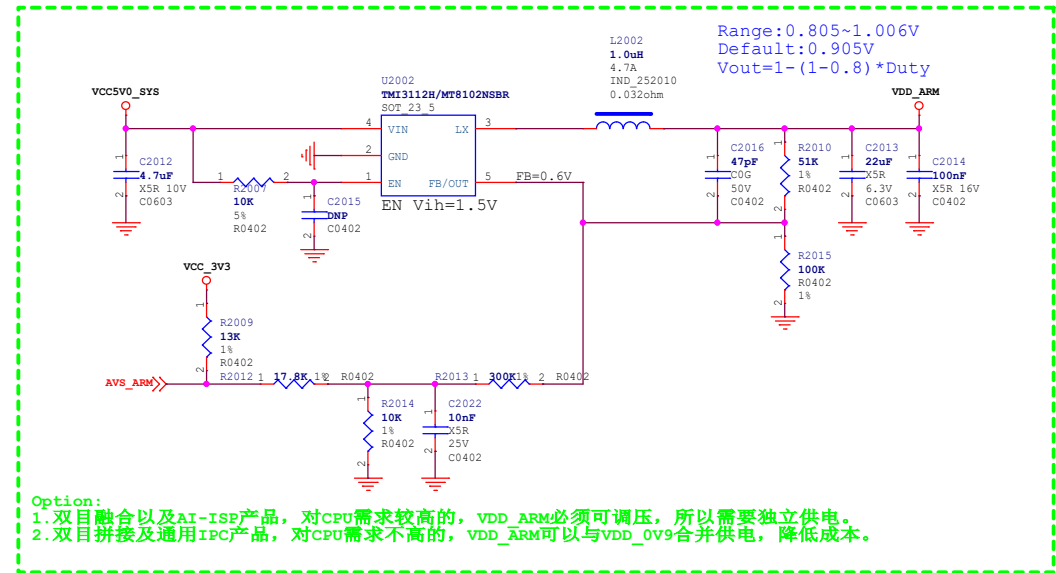


VCC5V0\_SYS--->VDD\_0V9  
Setp 1

Note:  
需要用到高算力的RV1106G3产品, VDD\_0V9需要定频0.95V.  
此时不建议VDD\_ARM与VDD\_0V9合并供电, 易造成功耗增加.

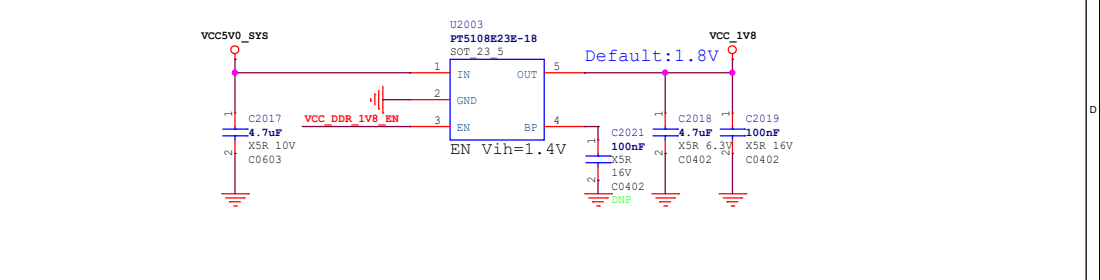


VCC5V0\_SYS--->VDD\_ARM  
Setp 1

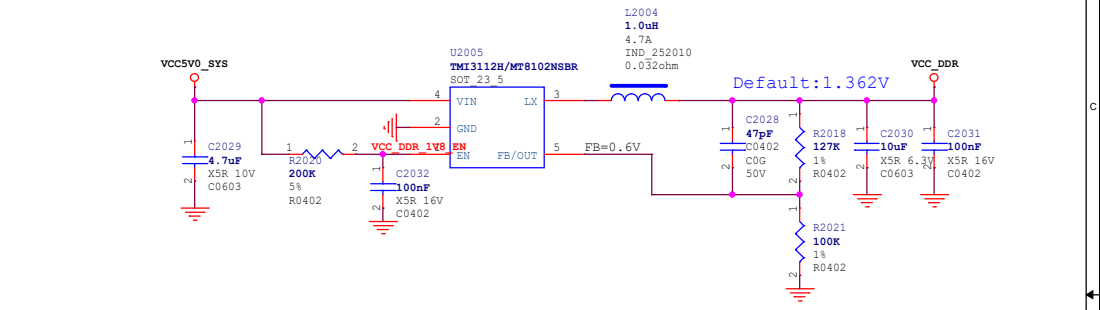


Option:  
1. 双目融合以及AI-ISP产品, 对CPU需求较高的, VDD\_ARM必须可调节, 所以需要独立供电。  
2. 双目拼接及通用IPC产品, 对CPU需求不高的, VDD\_ARM可以与VDD\_0V9合并供电, 降低成本。

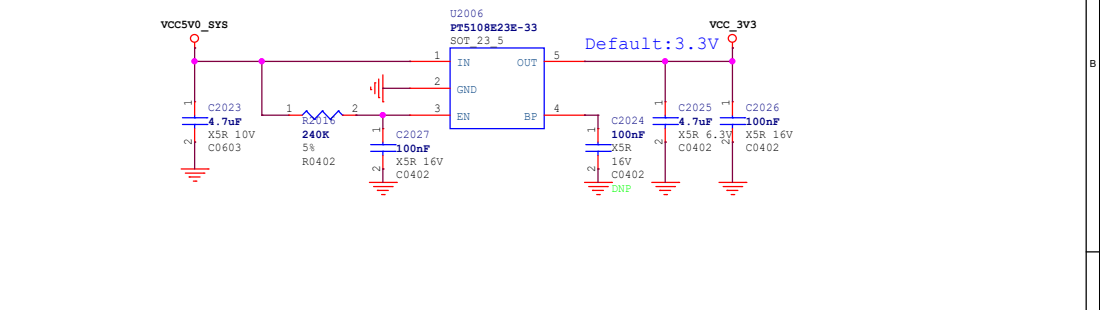
VCC5V0\_SYS--->VCC\_1V8  
Setp 2



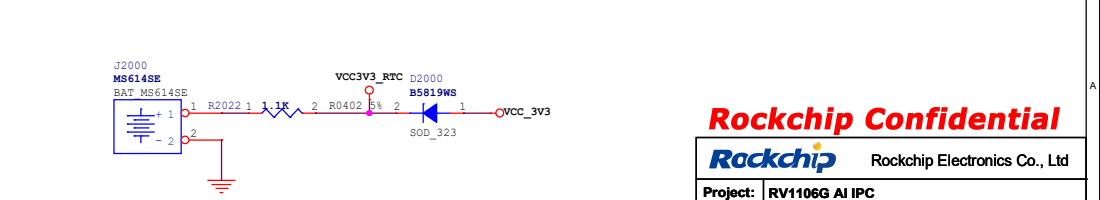
VCC5V0\_SYS--->VCC\_DDR  
Setp 2



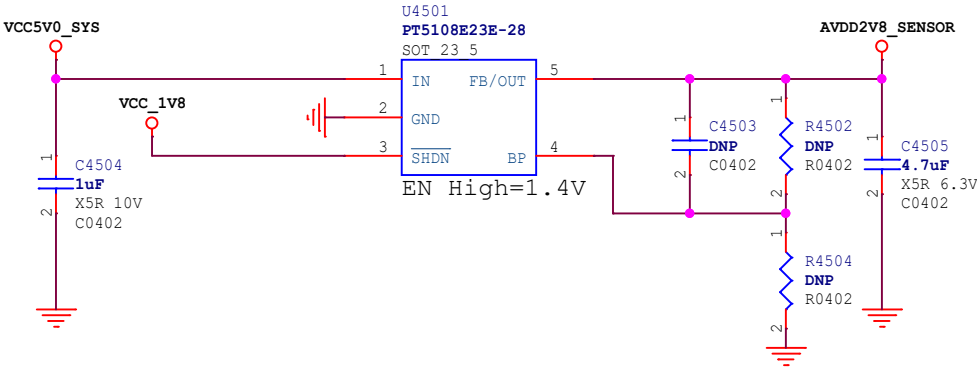
VCC5V0\_SYS--->VCC\_3V3  
Setp 3



RTC Power

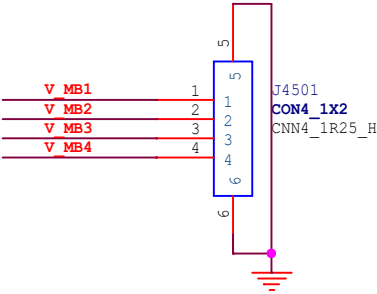
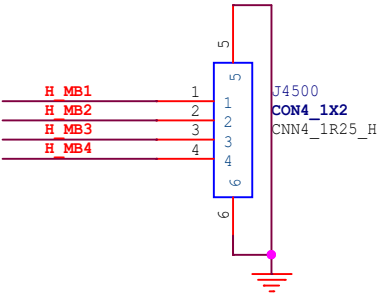
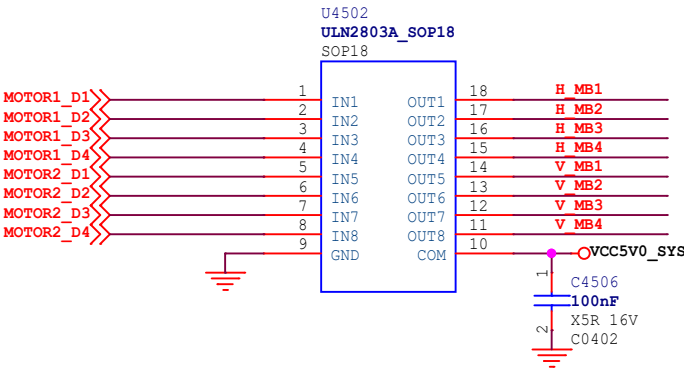


VCC5V0\_SYS--->AVDD2V8\_SENSOR




Note:  
Default power-on timing:  
All three power on at the same time.  
Or DOVDD(VCC\_1V8)-->DVDD(VCC\_1V5)-->AVDD(VCC\_2V8)

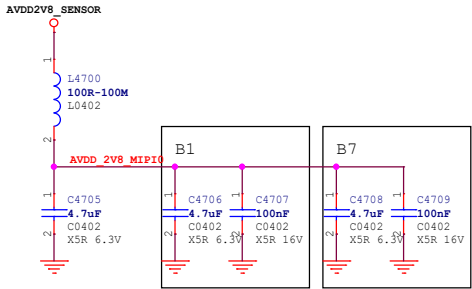
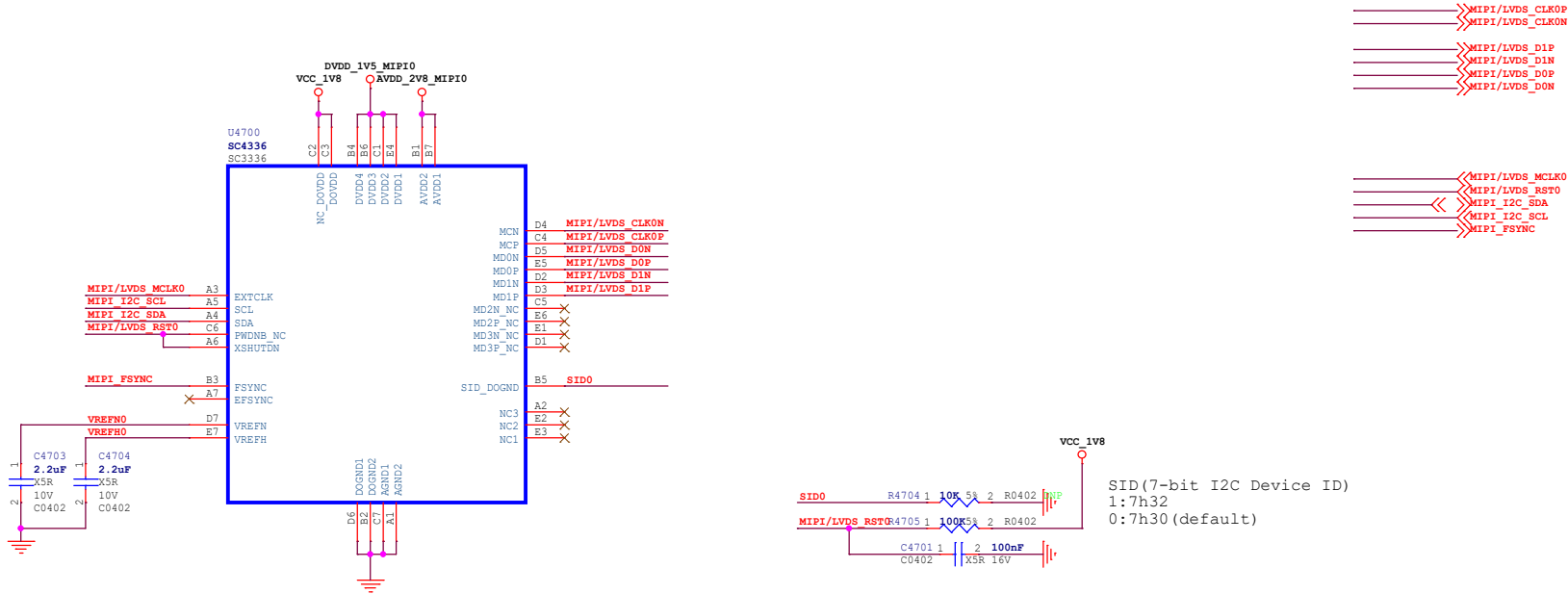
Motor



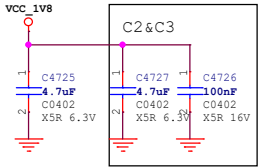
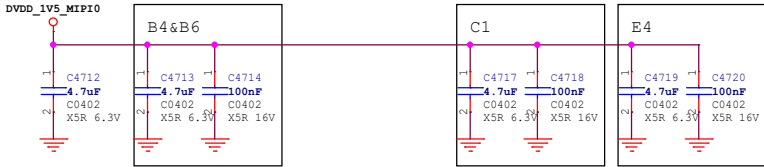
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Project:	RV1106G AI IPC		
File:	45.VI-Camera Power		
Date:	Friday, November 10, 2023		Rev: V1.3
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		Sheet:	12 of 20

Sensor0 : Master



Note:  
The built-in LDO power supply is used by default

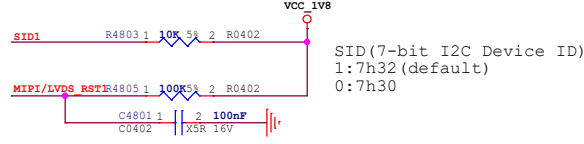
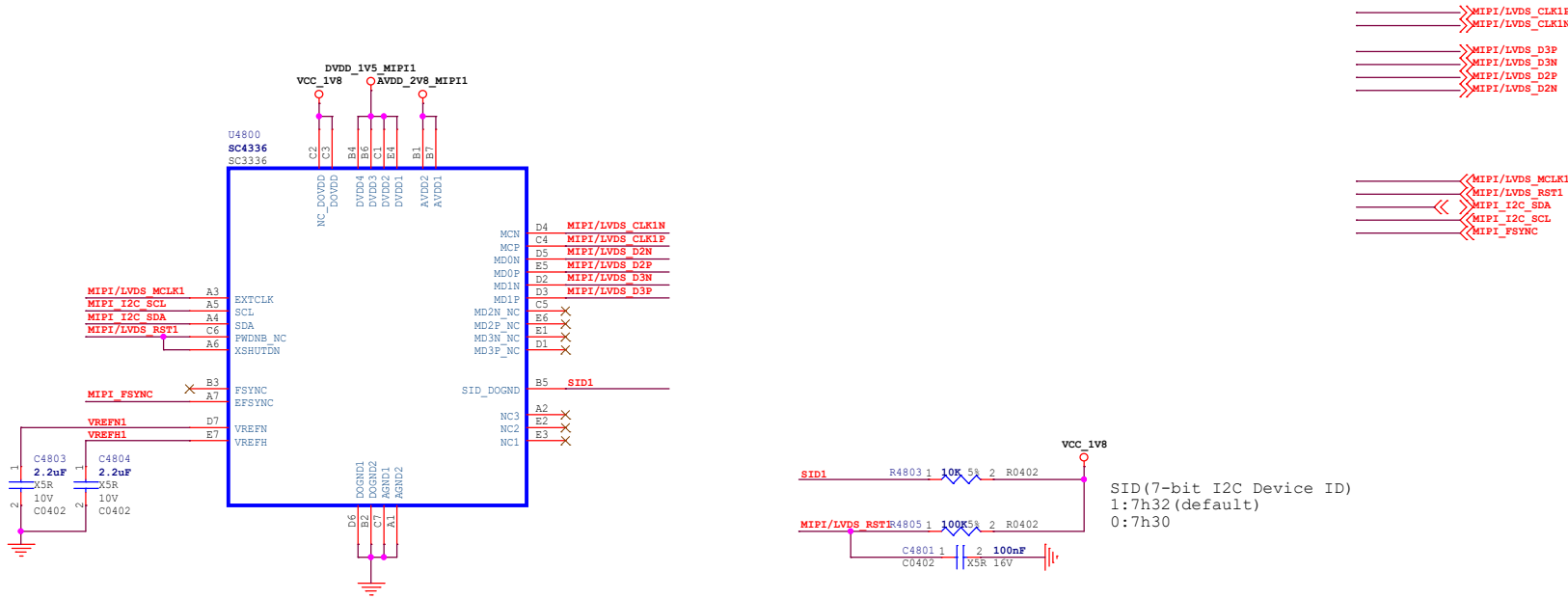


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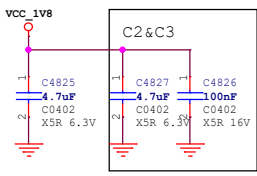
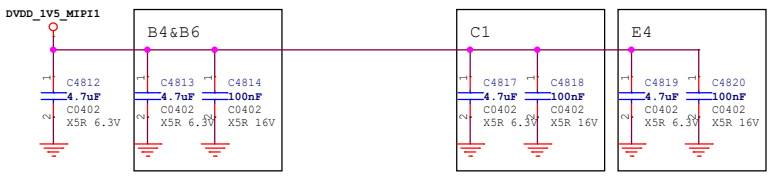
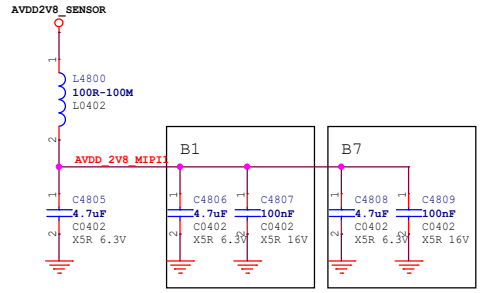
Project:	RV1106G AI IPC		
File:	47.VI-Camera Master		
Date:	Monday, December 25, 2023	Rev:	V1.3
Designed by:	Linux	Reviewed by:	Default
Sheet:	13 of 20		

Sensor1 : Slave



SID(7-bit I2C Device ID)  
1:7h32(default)  
0:7h30

Note:  
The built-in LDO power supply is used by default

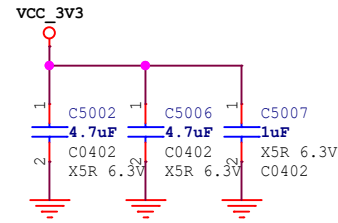
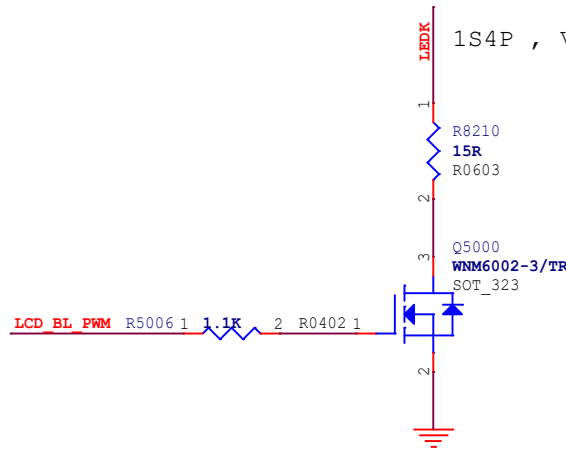
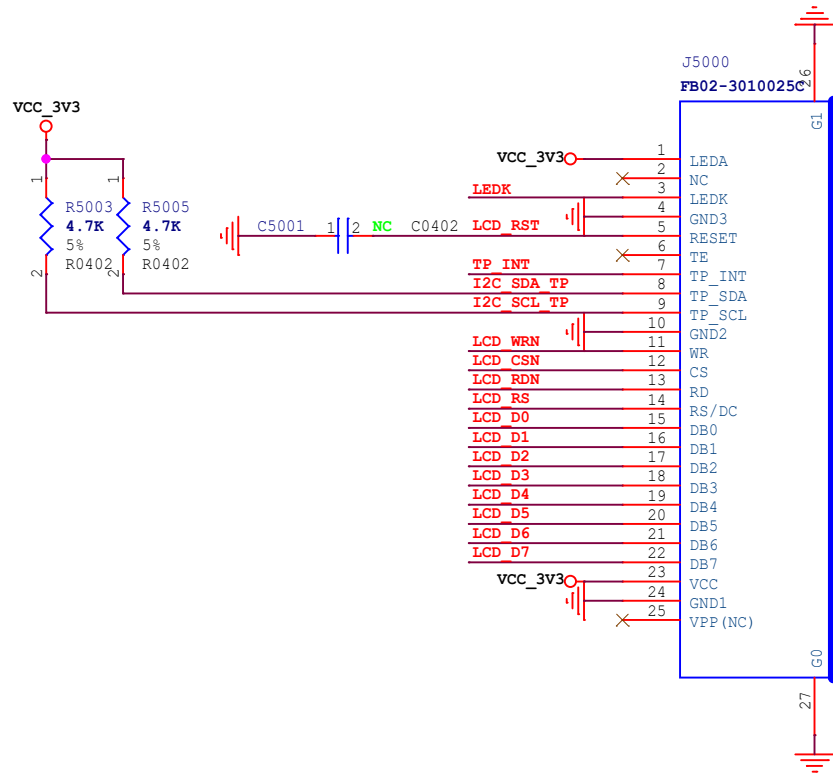
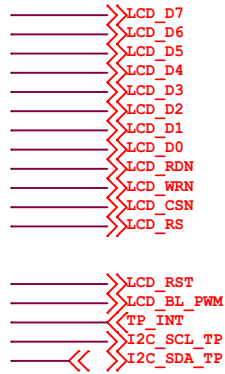


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Project:	RV1106G AI IPC		
File:	48.VI-Camera Slave		
Date:	Friday, November 10, 2023	Rev:	V1.3
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Panel and TP



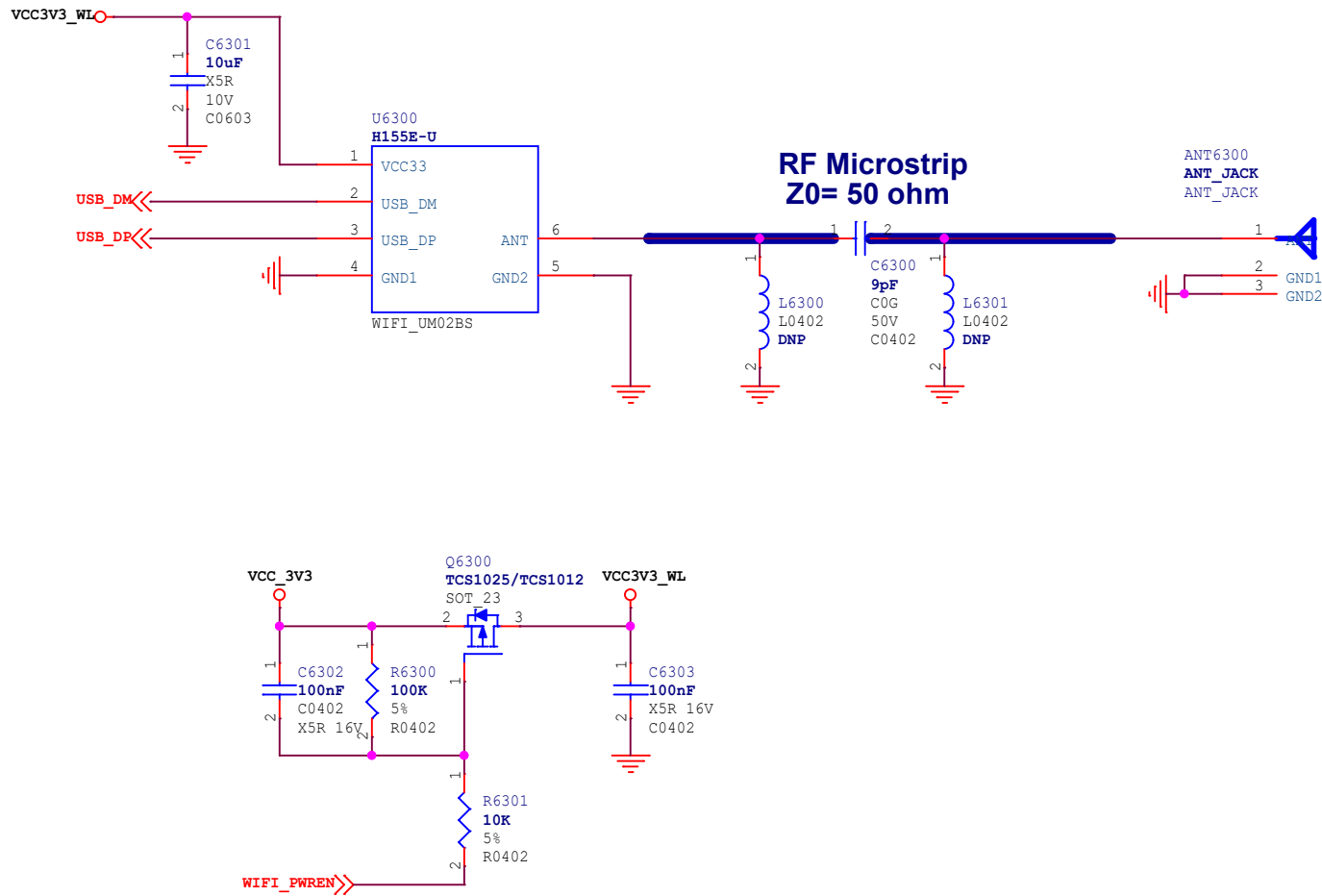
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Project:	RV1106G AI IPC				
File:	50.VO-MCU Panel				
Date:	Friday, November 10, 2023			Rev:	V1.3
Designed by:	Linux	Reviewed by:	Default	Sheet:	15 of 20

USB WIFI Module



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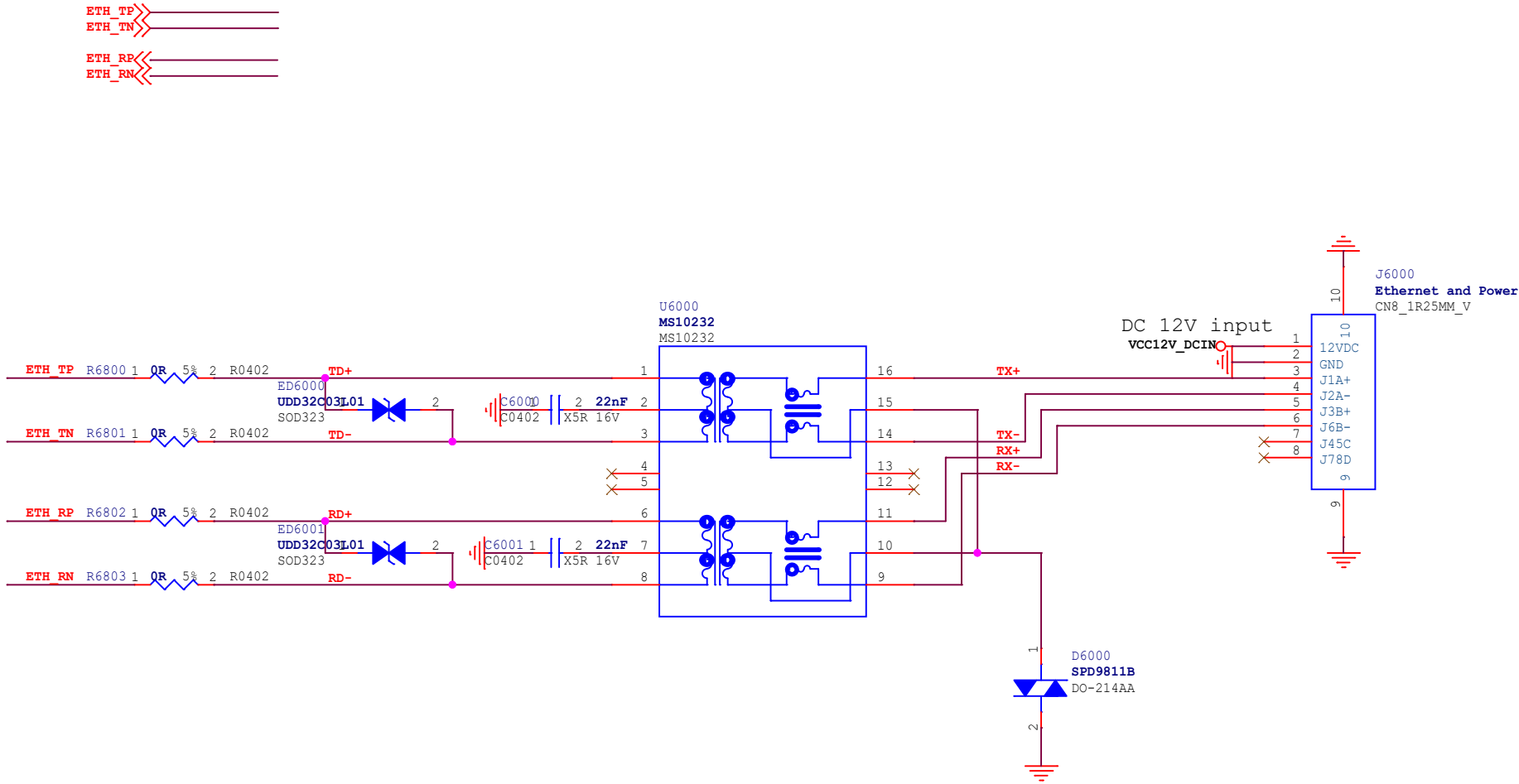


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Project:	RV1106G AI IPC			
File:	63.WIFI-USB			
Date:	Friday, November 10, 2023		Rev:	V1.3
Designed by:	Linux	Reviewed by:	Default	Sheet: 16 of 20



Ethernet



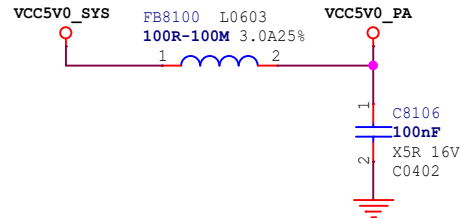
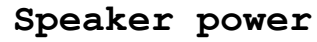
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Project:	RV1106G AI IPC		
File:	68.Ethernet-FEPHY_Embed		
Date:	Friday, November 10, 2023	Rev:	V1.3
Designed by:	Linux	Reviewed by:	Default
Sheet:	17	of	20

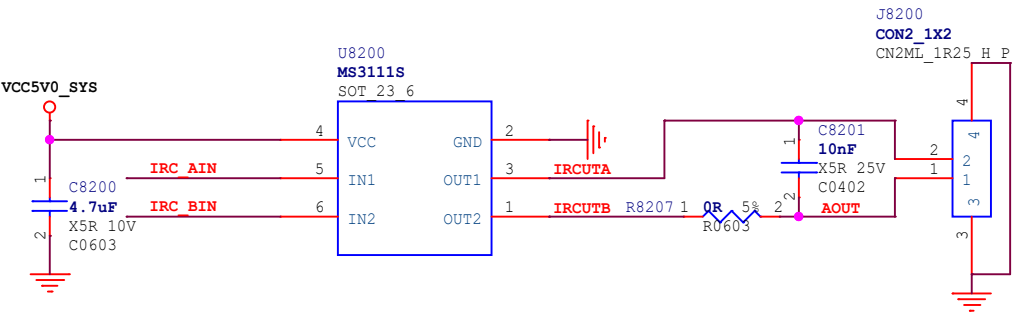
NOTE:CODEC\_AVSS and LINEOUT are routed according to the difference rule;



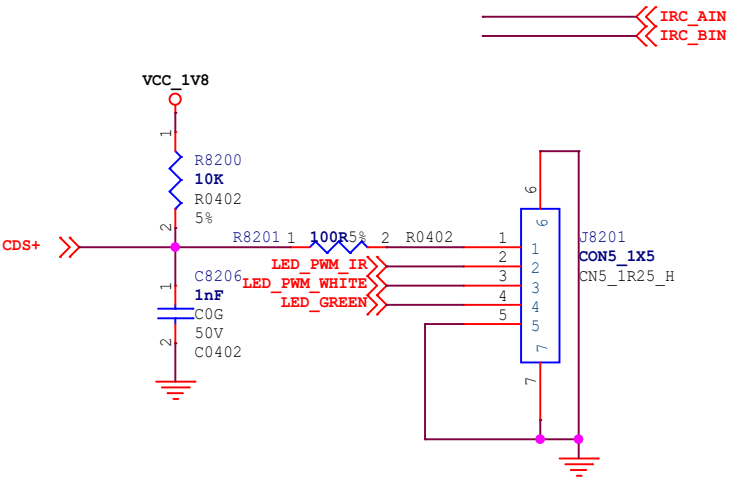
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<b>Project:</b>	<b>RV1106G AI IPC</b>				
<b>File:</b>	<b>70.Audio Port</b>				
<b>Date:</b>	Friday, November 10, 2023			<b>Rev:</b>	V1.3
<b>Designed by:</b>	Linux	<b>Reviewed by:</b>	Default	<b>Sheet:</b>	18 of 20

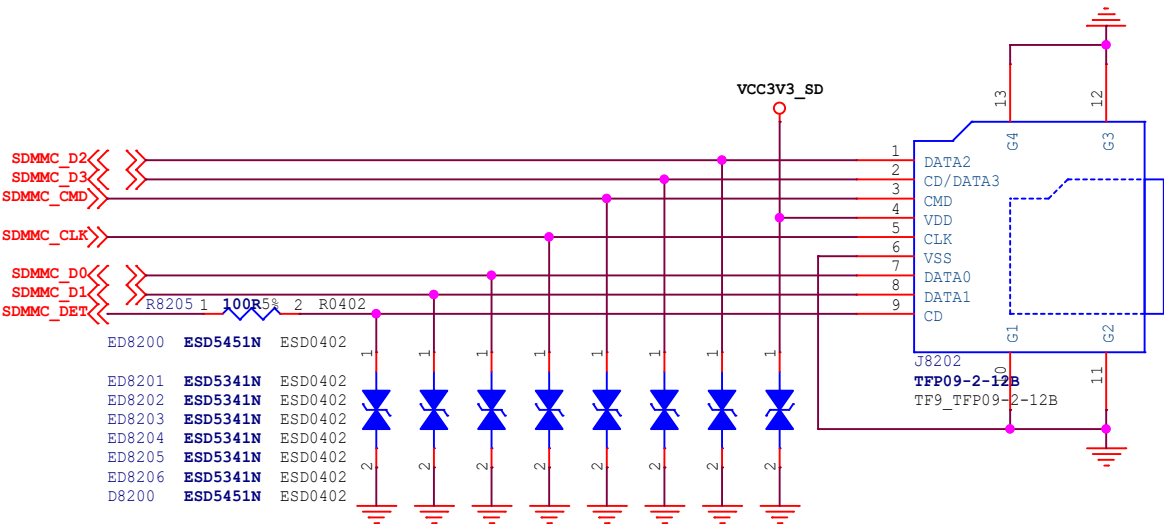
IR-CUT Drive



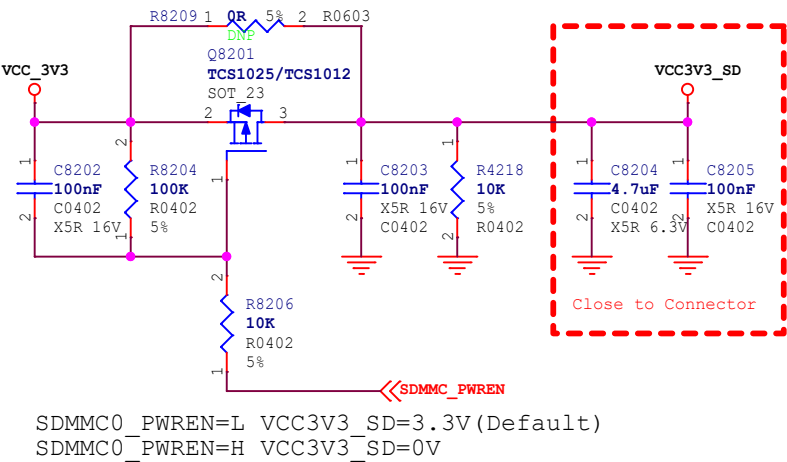
CDS&LED




Micro-SD Card



Card Power



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Project:	RV1106G AI IPC		
File:	82.Micro-SD Card/IRCUT/CDS		
Date:	Friday, November 10, 2023		Rev: V1.3
Designed by:	Linux	Reviewed by: Default	Sheet: 19 of 20

